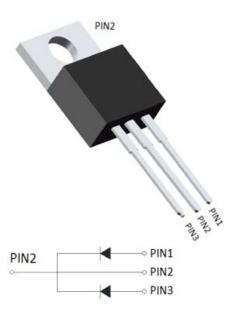


# MBR1080CT THRU MBR10200CT



# **Schottky Diodes**



### **Features**

- High frequency operation
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

### **Typical Applications**

Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

#### **Mechanical Data**

• Package: TO-220AB

Molding compound meets UL 94 V-0 flammability

rating, RoHS-compliant

• Terminals: Tin plated leads, solderable per J-STD-

002 and JESD22-B102

• Polarity: As marked

### ■Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	MBR1080CT	MBR10100CT	MBR10120CT	MBR10150CT	MBR10200CT
Device marking code			MBR1080CT	MBR10100CT	MBR10120CT	MBR10150CT	MBR10200CT
Repetitive Peak Reverse Voltage	VRRM	V	80	100	120	150	200
Average Rectified Output Current @60Hz sine wave, R-load, Ta=25℃	Ю	Α	10				
Surge(Non-repetitive)Forward Current @60Hz half sine-wave, 1 cycle, T <sub>a</sub> =25℃	IFSM	Α	100				
Current Squared Time @1ms≤t≤8.3ms Tj=25°C	l²t	A <sup>2</sup> s	41				
Storage Temperature	T <sub>stg</sub>	$^{\circ}$	-55 ~ +150				
Junction Temperature	Tj	$^{\circ}$	-55 ~ <b>+</b> 150				

## **■Electrical Characteristics** (T<sub>a</sub>=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	MBR1080CT	MBR10100CT	MBR10120CT	MBR10150CT	MBR10200CT
Maximum instantaneous forward voltage drop per diode	VFM	V	IFM=5.0A	C	).85	0	.9	0.95
Maximum DC reverse current	IRRM1	4	VRM=VRRM T <sub>a</sub> =25°C	0.1				
at rated DC blocking voltage per diode	IRRM2	mA	VRM=VRRM T <sub>a</sub> =100℃	20				

Note1:Pulse test:300uS pulse widh,1% duty cycle

Note2:Pulse test:pulse widh 40mS

# MBR1080CT THRU MBR10200CT

### **■Thermal Characteristics** (Ta=25 °C Unless otherwise specified)

PARA	METER	SYMBOL	UNIT	MBR1080CT	MBR10100CT	MBR10120CT	MBR10150CT	MBR10200CT
Thermal Resistance	Between junction and case	R <sub>θJ-C</sub>	°CMV			2.0		

**■Ordering Information** (Example)

PREFERED P/N UNIT WEIGHT(g)		MINIIMUM INNER BOX PACKAGE(pcs) QUANTITY(pc		OUTER CARTON QUANTITY(pcs)	DELIVERY MODE	
	MBR1080CT THRU MBR10200CT	Approximate 1.9	50	1000	5000	Tube

## **■Characteristics** (Typical)

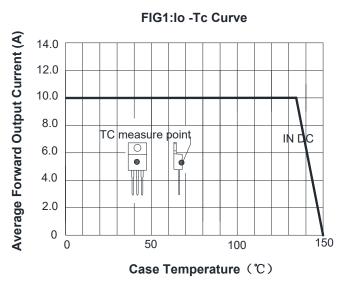


FIG2:Surge Forward Current Capability

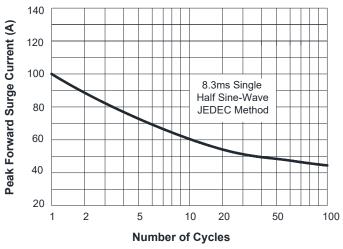


FIG3: Forward Voltage

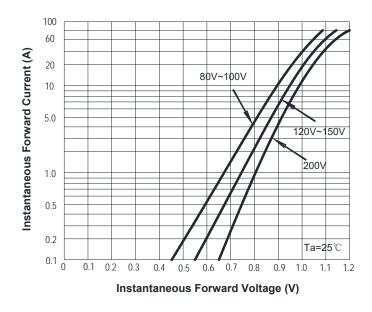
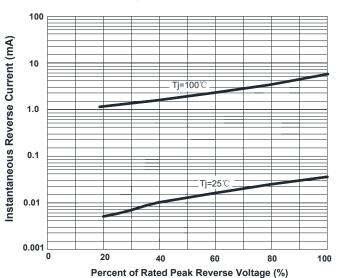


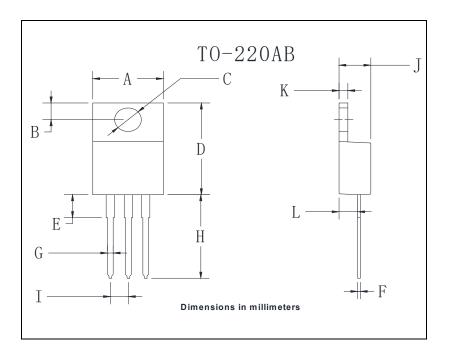
FIG.4: Typical Reverse Characteristics





# MBR1080CT THRU MBR10200CT

### **■Outline Dimensions**



TO-220AB					
Dim	Min	Max			
Α	9.95	10.35			
В	2.55	2.95			
С	3.8	4.0			
D	14.95	15.25			
Е	3.75	4.25			
F	0.26	0.5			
G	0.68	0.94			
Н	13.4	13.9			
1	2.35	2.65			
J	4.38	4.78			
K	1.14	1.4			
L	2.37	2.79			

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